

EQCO400T8 UTP Cable Equalizer

Features

- Multi-Rate Adaptive Equalization for UTP Cables
 up to 500 Mbps
- Supports General 8B/10B Coded Signaling over UTP
- Supports FireWire IEEE 1394b at S400, S200 and S100 Data Rates
- Seamless Connection with any IEEE1394b
 Compliant PHY
- Internal Termination Resistors for Low External Discrete Count
- Fully Compatible with Power over Ethernet⁽¹⁾
- Carrier Detect and Mute Functionality with Direct Light Emitting Diode Driving Capability
- Single 3.3V Supply
- Low-Power Operation
 - 42 mA (140 mW) Active
 - 4.25 mA (14 mW) Mute
- 16-pin, 0.65 mm Pin Pitch, 4 mm QFN Package
- · Pb-free and RoHS Compliant

Typical Equalization Performance

General Description

The EQCO400T8 is a multi-rate adaptive cable equalizer designed to restore signals received over Cat 5 or Cat 6 Unshielded Twisted Pair (UTP) cable. For correct operation, the signals must be NRZ (Non-Return-to-Zero) encoded, DC-balanced with a maximum run length of 10 bits and have a speed (edge rate) of between 100 Mbps and 500 Mbps.

Device	Bit Rate	1394 Data Rate	Range ⁽²⁾ using		
Device	(8B/10B Coding)	1554 Dala Nale	Cat 5e	Cat 6	
EQCO400T8	125 Mbps	S100	0m-85m	0m-85m	
	250 Mbps	S200	0m-75m	0m-85m	
	500 Mbps	S400	0m-50m	0m-75m	

Note 1: IEEE 802.3-2008, clause 33 - "Power over Ethernet" (formerly known as IEEE 802.3af)

2: Measured on UTP pairs 1, 2, 3 and 6 as per IEEE 1394-2008 using recommended Coilcraft magnetics as per Table 2-1.

Table of Contents

1.0	Device Overview	. 3
	Application Information	
	Electrical Characteristics	
4.0	Packaging	13

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com** or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; http://www.microchip.com
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com to receive the most current information on all of our products.

1.0 DEVICE OVERVIEW

The EQCO400T8 is ideally suited for long-haul IEEE 1394b-2002 connections over Category 5 or Category 6 Ethernet cable at the S400 data rate. It can also be used at S200 and S100 data rates over even longer cables, as illustrated in the typical long-haul connection in Figure 1-1. The EQCO400T8 connects seamlessly to any IEEE 1394b-2002 compliant physical layer controller (PHY).

The achievable connection reach with the EQCO400T8 depends on the input jitter tolerance of the IEEE 1394 PHY and the quality of the connectors and cables used. Figure 1-1 shows the typical performance with CAT5e and CAT6 cables under nominal conditions.



FIGURE 1-1: LONG-HAUL IEEE 1394B-2002, IEEE 1394-2008 CONNECTION



FIGURE 1-2: EQCO400T8 PIN DIAGRAM (VIEWED FROM TOP)

TABLE 1-1: **EQCO400T8 PIN DESCRIPTIONS**

Pin Number	Pin Name	Signal Type	Description
2, 11	VCC	Power	Connect to +3.3V power supply.
5, 13	GND	Power	Connect to power supply ground.
1, 3	SDIp/SDIn	LVDS Input	Differential serial data input pair.
12, 10	SDOp/SDOn	LVDS Output	Differential serial data output pair.
6	CLI	Analog Output	Cable length indicator: Analog voltage can be used to indicate the length of the cable being equalized; this gives an indication of the amount of equalization being applied. A higher output voltage results from more compensation being used to recover the signal. Leave unconnected when not used.
7	LED	Output	Carrier detect with light emitting diode driver. High means a valid input signal, and SDOp/SDOn are turned on. Low means no RX signal or the signal is too low, and SDOp/ SDOn are muted. This pin can source up to 3 mA to directly drive an LED. Leave unconnected when not in use.
4, 8, 9, 14, 15, 16	NC		Leave unconnected.





1.1 SDIp/SDIn

SDIp/SDIn together form a differential input pair that is connected to the receive signal pair of the cable. It is the differential voltage between these pins that the EQCO400T8 analyzes and adaptively equalizes for signal level and frequency response. The equalizer automatically detects and adapts to signals with different edge rates, e.g. S100, S200 and S400.

Both SDI+ and SDI- inputs are terminated by 50Ω to VCC on-chip. It is advised to isolate the inputs from the UTP via a transformer, as shown in Figure 2-1.

1.2 SDOp/SDOn

SDOp/SDOn together form a differential pair outputting the reconstructed far-end transmit signal. The signals can be connected via capacitive coupling directly to the RX signal pair of a standard IEEE1394b PHY.

The EQCO400T8 uses Current Mode Logic (CML) drivers with source matching for the 110Ω transmission line.

1.3 CLI

The EQCO400T, being a fully analog equalizer, has a continuous transfer function with respect to the equalization applied. CLI (Cable Length Indicator) is an analog output. The voltage on the pin is proportional to the amount of equalization being applied.

CLI can be used qualitatively to indicate the length of the cable being equalized; the higher the voltage, the longer the cable. However the CLI pin voltage depends on a number of factors, including connector quality, device temperature and to a certain degree on chip-tochip variations, and as such cannot be used for accurate cable length measurement.

Figure 1-4 illustrates the voltage at CLI for a typical CAT6 cable.





1.4 LED

LED is an output that detects and indicates sufficient differential signal power at SDIp/SDIn for a link to be established.

If the received signal at the serial inputs is either not present or too small for proper reconstruction of the output (i.e. a signal with amplitude < 40 mV) the voltage on LED is driven low; if sufficient signal power is detected, the voltage at LED will be driven high. When high, the pin can source up to 3 mA, enabling it to be used to directly drive an LED. The LED will thus be on when a signal is detected, and off otherwise. It is advised to use a high-efficiency LED. The output from this pin is current limited, and no series resistor is required.

1.5 Equalizer Operation



The EQCO400T8 is an equalizer with unique characteristics:

· Auto-adaptive

The equalizer controls a multiple-pole analog filter which compensates for attenuation of the cable, as illustrated in Figure 1-5. The filter frequency response needed to restore the signal is automatically determined by the device using a time-continuous feedback loop that measures the frequency components in the signal. Upon the detection of a valid signal, the control loop converges within a few microseconds.

Variable gain

The EQCO400T8 has variable gain to work independently of the transmit amplitude of the line driver.

The equalizer can be used with any IEEE1394b compliant transmitter. The standard⁽¹⁾ requires a differential transmit amplitude in the range of 475 mV to 800 mV.

Multi-speed

The EQCO400T8 works at data rates from 100 Mbps to 500 Mbps. In particular, it supports the S400, S200 and S100 data rates specified in the IEEE Standard 1394b-2002.

Carrier detect/auto-mute to save power

The EQCO400T8 will automatically mute its output driver when no incoming signal is present. The EQCO400T8 estimates the remote transmit amplitude by measuring the low-frequency components of the signal. When the low-frequency amplitude is approximately 190 mV or higher, the output stage is turned on. Auto-mute reduces the power consumption from 140 mW to less than 14 mW.

Example equalizer performance measurements can be found in Appendix B: Typical Operating Characteristics. Note 1: IEEE 1394-2008, Standard for High-Performance Serial Bus

NOTES:

2.0 APPLICATION INFORMATION

Figure 2-1 illustrates a typical schematic implementation. In this diagram, data is transmitted on pins 1 and 2, and received on pins 3 and 6 of the RJ45.



To improve isolation from noise on the board power plane, it is recommended to power the equalizer through a ferrite bead. A 0.1 μ F decoupling capacitor should be placed as close as possible to each VCC pin. Ground vias should be placed as close as possible to the device GND pins to minimize inductance. To reduce electromagnetic emissions, it may be advised to place a 6.8 pF capacitor in between TPB and TPB* (transmit LVDS) of the PHY to reduce the rise/fall time of the transmitted signals. If fitted, the capacitor should be placed as close as possible to the PHY.

2.1 Guidelines for PCB Layout

Because signals are strongly attenuated by a long cable, special attention must be paid on the PCB layout between the RJ45 connector and the EQCO400T. The EQCO400T8 should be as close as is practical to the RJ45 connector. Traces between the RJ45, the transformer and the EQCO400T8 should be either single-ended 50Ω traces or, preferably, differential traces with a differential impedance of 100Ω . To avoid noise pickup, these traces should be placed as far away as possible from other traces carrying digital signals or fast switching signals. All differential traces should be matched in length to minimize time of arrival skew.

For best EMC performance, identical common-mode chokes should be used on the unused pairs to those used on the signal pairs as shown in Figure 2-1. This ensures the impedance seen by all conductors in the UTP cable is the same.

A reference design is available on request.

2.2 Recommended Magnetics

The following magnetics are recommended for use with EQCO400T:

TABLE 2-1:RECOMMENDED MAGNETICS

Component	Part Number
Transformers (1:1 with center tap) Two per channel	Coilcraft WBC1-1TLB
Common-mode chokes Four per channel	Coilcraft 1206USB-113MLB

Note: Operation with magnetics other than the recommended components cannot be guaranteed.

2.3 Connector Pins and Cable Connection

The EQCO400T8 does not support auto-crossover. If required, this must be implemented externally to the device.

To be the same as 100BaseT Ethernet, IEEE Standard 1394-2008 recommends that data is transmitted on RJ45 pins 1 and 2, and received on pins 3 and 6. If both sides of the long-haul UTP connection are configured in this way, a crossover cable or patch cord must be used.

If one side of the UTP connection transmits data on RJ45 pins 1 and 2 and receives data on pins 3 and 6, and the other side transmits data on RJ45 pins 3 and 6 and receives data on pins 1 and 2, a straight-through cable must be used.

If maximum reach is the highest priority and if a closed system is created, it is recommended to use pins 1 and 2 for transmit (receive) and pins 7 and 8 for receive (transmit). This reduces near-end crosstalk (NEXT) significantly, which will give a bonus on the maximum cable span; especially for CAT5e.

2.4 Supplying Power over the UTP Cable

The EQCO400T8 is fully compatible with the Power Over Ethernet standard, allowing standard POE chip sets to be used at the ends of the cable to transmit power to a remote device. The unused pairs (RJ45 pins 4,5 and 7,8) are most easily used for the transmission of power. The signal pairs can also be used as specified in the standard, but in this case, careful choice of magnetic components is required to conform to both the DC requirements of POE and the AC requirements of IEEE-1394.

A POE reference design is available on request.

3.0 ELECTRICAL CHARACTERISTICS

3.1 Absolute Maximum Ratings

Stresses beyond those listed under this section may cause permanent damage to the device. These are stress ratings only and are not tested. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TABLE 3-1: ABSC	DLUTE MAXIMUM RATINGS
-----------------	-----------------------

Parameter	Min.	Тур.	Max.	Units	Conditions
Storage Temperature	-65		+150	°C	
Ambient Temperature	-55	_	+125	°C	Power Applied
Operating Temperature	-40	_	+85	°C	Normal Operation (VCC = 3.3V ±5%)
Supply Voltage to Ground	-0.5	_	+4.0	V	
DC Input Voltage	-0.5	_	+4.0	V	
DC Voltage to Outputs	-0.5	_	+4.0	V	
Current into Outputs	_	—	90	mA	Outputs Low

TABLE 3-2: MAXIMUM CURRENT CONSUMPTION AT 3.3V

Description	Мах	Unit
No input signal, LED is low, output driver is disabled	4.25	mA
Valid input, LED is high, output driver is enabled	42.5	mA

TABLE 3-3:ELECTRICAL CHARACTERISTICS (OVER THE OPERATING VCC AND -40°C TO
+85°C RANGE)

Parameter	Min.	Тур.	Max.	Unit	Description
Power Supply					
VCC	3.135	3.3	3.465	V	
VCC	100	500	600	Mbps	Signaling rate (NRZ, 8b/10b encoded)
SDIp/SDIn Input					
Differential Input Voltage Swing	475	—	800	mV	V_{SDIp} - V_{SDIn} measured at cable input
LVDSI _{min}	_	40	—	mV	Minimum differential input for fully reconstructed output
	—	3.3	—	V	Common-mode input voltage
R _{input}	—	50	_	Ω	Single-ended; to VCC

TABLE 3-3:ELECTRICAL CHARACTERISTICS (OVER THE OPERATING VCC AND -40°C TO
+85°C RANGE)

SDOp Connection to Coax	[
LVDSo		440		mV	Differential output voltage swing V_{SDOp} - V_{SDOn} (50 Ω load to VCC on each output) LED is high.
	_	VCC- LVDSo/2	_	V	Common-mode output voltage
SDO _{off}	—	VCC	—	V	Output voltage with disabled driver. Single-ended; LED is low.
R _{output}	—	55	—	Ω	Single-ended; to VCC
Rise/Fall Time	100	190	260	ps	20% to 80%
LED					
V _{oh}	1.5	VCC		V	Differential input voltage at cable input > 250 mV
V _{ol}	_	GND	0.8	V	Differential input voltage at cable input < 40 mV
CLI					
V _{oh}	_	1.2	_	V	Output voltage at maximum cable length
V _{ol}		2.6	_	V	Output voltage at maximum cable length

4.0 **PACKAGING INFORMATION**

4.1 Package Marking Information

16-Lead Plastic Quad Flat, No Lead Package - 4x4x0.9 mm Body [QFN]



Legenc	I: XXX Y YY WW NNN (e3)	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn)
Note:	* In the events be carried	This package is Pb-free. The Pb-free JEDEC designator ((a)) can be found on the outer packaging for this package. ent the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available characters mer-specific information.

16-Lead QFN (4x4x0.9 mm)

16-Lead Plastic Quad Flat, No Lead Package (8E) - 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



16-Lead Plastic Quad Flat, No Lead Package (8E) - 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units				
Dimension	Dimension Limits			MAX	
Number of Pins	Ν	16			
Pitch	е		0.65 BSC		
Overall Height	Α	0.80	0.87	0.95	
Standoff	A1	0.00	0.02	0.05	
Terminal Thickness	A3	0.20 REF			
Overall Width	E	4.00 BSC			
Exposed Pad Width	E2	1.95 2.05 2.15			
Overall Length	D		4.00 BSC		
Exposed Pad Length	D2	1.95	2.05	2.15	
Terminal Width	b	0.25	0.30	0.35	
Terminal Length	L	0.45	0.55	0.65	
Terminal-to-Exposed-Pad	K		0.425 REF		

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-259B Sheet 2 of 2

16-Lead Plastic Quad Flat, No Lead Package (8E) - 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	X2			2.15
Optional Center Pad Length	Y2			2.15
Contact Pad Spacing	C1		3.625	
Contact Pad Spacing	C2		3.625	
Contact Pad Width (X16)	X1			0.30
Contact Pad Length (X16)	Y1			0.725
Contact Pad to Center Pad (X16)	G1	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2259A

APPENDIX A: REVISION HISTORY

Revision B (February 2016)

- Updated Section 4.1 "Package Marking Information".
- Removed electrostatic discharge ratings from Table 3-1.
- Minor typographical changes.

Revision A (July 2015)

• This is the initial release of the document in the Microchip format. This replaces EqcoLogic document version 2.4.

Version	Date	Author	Comments	
2.4	2/27/14	M. Kuijk	Removed data about previous version, added patent information.	
2.3	5/3/09	S.E. Ellwood	Added information on EQCO400T-8.	
2.2	12/8/08	S.E. Ellwood	Correction to Table 2-1.	
2.1	11/2/08	S.E. Ellwood	Added Table 2-1 Recommended Magnetics, changed postal address.	
2.0	7/22/08	S.E. Ellwood	Released. New document.	
1.1	2/2/06	K. Van Den Brande		

TABLE A-1: REVISION HISTORY

TYPICAL OPERATING APPENDIX B: **CHARACTERISTICS**

Figures B-1 to B-14 have been made under the following conditions: Receive signal on pair 3, 6; S400; 630 mV Transmit amplitude. Crosstalk source on pair 1, 2; S400; 630 mV Transmit amplitude.

B.1 Auto-Adaptive



FIGURE B-2: **30M CAT6 CABLE BEFORE** EQUALIZER



FIGURE B-3: **60M CAT6 CABLE BEFORE** EQUALIZER



FIGURE B-4: **2M CAT6 CABLE AFTER EQUALIZER** Graphs Results
 Bit Rate:
 500.0000 MI

 TJ(1E-12):
 211.6 mUI

 PJ(δ-δ):
 3.74 mUI

 PJ(rms):
 1.266 mUI
 Pat Length: 511 bits DJ(&-&): 185.8 mUI DDJ(p-p): 188.1 mUI Div Ratio: 1:1 Src: RJ(rms): 1.834 mUI DCD: 11.17 mUI Setup & Info DCD: 11.17 mU ISI(p-p): 184.7 mU

FIGURE B-5: **30M CAT6 CABLE AFTER** EQUALIZER







FIGURE B-1: **2M CAT6 CABLE BEFORE**

FIGURE B-7: 90M CAT6 CABLE BEFORE EQUALIZER



B.2 CAT5e

The crosstalk generated in a CAT5e system is much higher than in a CAT6 system. This reduces the maximum cable length over which a link can be maintained.

FIGURE B-8: 70M CAT5E



B.3 Variable Gain



FIGURE B-9: 300 MV TRANSMIT AMPLITUDE (80M CAT6 CABLE)

FIGURE B-10: 90M CAT6 CABLE AFTER EQUALIZER



 Results
 Div Rat Io: 1:1
 Src: 2

 TU(E+12): 205,7 mUI
 DU(F=3): 103,2 mUI
 DU(F=3): 7.01 mUI

 PJ(6+5): 7.01 mUI
 DDU(p-p): 116.6 mUI
 DC(r=5): 7.302 mUI

 PJ(r=5): 10,75 mUI
 DDU(p-p): 116.6 mUI
 DC(r=5): 103,20 mUI

FIGURE B-11: 70M CAT5E - RX ONLY





© 2006-2016 Microchip Technology Inc.

B.4 Multi-Speed

FIGURE B-13: S200B, 110M CAT6 CABLE



FIGURE B-14: S100B, 130M CAT6 CABLE



THE MICROCHIP WEB SITE

Microchip provides online support via our web site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- · Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://microchip.com/support

PRODUCT IDENTIFICATION SYSTEM

To order parts, including industrial, or obtain information, for e.g., on pricing or delivery, refer to the factory or the listed sales office.

_	PART NO.	I Temp. Range	Exa a)	amples: EQCO400T8/I = Industrial temperature 16-Lead QFN package
	Device	EQCO400T8		
	Temperature Range	I = -40°C to +85°C (Industrial temperature)		

Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELoQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, dsPIC, FlashFlex, flexPWR, Heldo, JukeBlox, KeeLoq, KeeLoq logo, Kleer, LANCheck, LINK MD, MediaLB, MOST, MOST logo, MPLAB, OptoLyzer, PIC, PICSTART, PIC32 logo, RightTouch, SpyNIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, ETHERSYNCH, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and QUIET-WIRE are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PureSilicon, RightTouch logo, REAL ICE, Ripple Blocker, Serial Quad I/O, SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademarks of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2006-2016, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

ISBN: 978-1-5224-0255-8



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Cleveland Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110

Canada - Toronto Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway

Harbour City, Kowloon Hong Kong Tel: 852-2943-5100 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Dongguan Tel: 86-769-8702-9880

China - Hangzhou Tel: 86-571-8792-8115 Fax: 86-571-8792-8116

China - Hong Kong SAR Tel: 852-2943-5100 Fax: 852-2401-3431

China - Nanjing Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian Tel: 86-29-8833-7252 Fax: 86-29-8833-7256 ASIA/PACIFIC

China - Xiamen Tel: 86-592-2388138 Fax: 86-592-2388130

China - Zhuhai Tel: 86-756-3210040 Fax: 86-756-3210049

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-3019-1500

Japan - Osaka Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7828

Taiwan - Taipei Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Dusseldorf Tel: 49-2129-3766400

Germany - Karlsruhe Tel: 49-721-625370

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Venice Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Poland - Warsaw Tel: 48-22-3325737

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

07/14/15